TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

## ULN2003AP, ULN2003AFW, ULN2004AP, ULN2004AFW

### 7CH DARLINGTON SINK DRIVER

The ULN2003AP/AFW Series are high-voltage, high-current darlington drivers comprised of seven NPN darlington pairs.

All units feature integral clamp diodes for switching inductive loads.

Applications include relay, hammer, lamp and display (LED) drivers.

#### **FEATURES**

- Output current (single output) 500 mA MAX.
- High sustaining voltage output
   50 V MIN. (ULN2003AP / AFW Series)
- Output clamp diodes
- Inputs compatible with various types of logic

Package Type-AP : DIP-16pinPackage Type-AFW : SOL-16pin

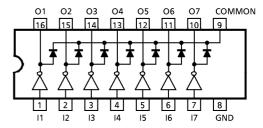
ULN2003AP ULN2004AP
ATTITUTE
DIP16-P-300-2.54A
ULN2003AFW ULN2004AFW
THEFT THE
SOL16-P-150-1.27A

Weight

DIP16-P-300-2.54A : 1.11 g (Typ.) SOL16-P-150-1.27A : 0.15 g (Typ.)

TYPE	INPUT BASE RESISTOR	DESIGNATION
ULN2003AP/AFW	2.7 k $\Omega$	TTL, 5 V CMOS
ULN2004AP/AFW	10.5 k $\Omega$	6~15 V PMOS, CMOS

### PIN CONNECTION (TOP VIEW)



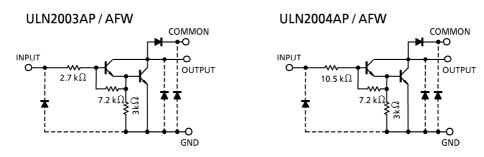
980910EBA1

- TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.

  The products described in this document are subject to the foreign exchange and foreign trade laws.
- The products described in this document are subject to the foreign exchange and foreign trade laws.
   The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA CORPORATION for any infringements of intellectual property or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any intellectual property or other rights of TOSHIBA CORPORATION or others.

The information contained herein is subject to change without notice.

### **SCHEMATICS** (EACH DRIVER)



(Note): The input and output parasitic diodes cannot be used as clamp diodes.

### MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
Output Sustaining Voltage		VCE (SUS)	-0.5~50	V	
Output Current		IOUT	500	mA / ch	
Input Voltage		V <sub>IN</sub>	-0.5~30	V	
Clamp Diode Reverse Voltage		V <sub>R</sub>	50	V	
Clamp Diode Forward Current		lF	500	mA	
Dawan Dissipation	AP	D-	1.47	w	
Power Dissipation	AFW	$P_{D}$	0.54/0.625 (Note)		
Operating Temperature		T <sub>opr</sub>	- 40~85	°C	
Storage Temperature		T <sub>stg</sub>	<b>-</b> 55∼150	°C	

(Note) : On glass epoxy PCB (30  $\times$  30  $\times$  1.6 mm Cu 50%)

### **RECOMMENDED OPERATING CONDITIONS** (Ta = $-40 \sim 85$ °C)

CHARACTER	ISTIC	SYMBOL	CONDITION		CONDITION		CONDITION		MIN. TYF		MAX.	UNIT
Output Sustaining	Voltage	V <sub>CE</sub> (SUS)	S)		0	_	50	V				
Output Current	AP		T <sub>pw</sub> = 25 ms 7 Circuits Ta = 85°C	Duty = 10% Duty = 50%	0	_	370 130					
	Δ Γ\Δ/	lout		Duty = 10%	0	_	233	mA / ch				
	AFW		T <sub>j</sub> = 120°C	Duty = 50%	0	_	70					
Input Voltage		V <sub>IN</sub>			0	_	24	<b>&gt;</b>				
Input Voltage	ULN2003A	V	I <sub>OUT</sub> = 400 mA h <sub>FE</sub> = 800		2.8	_	24	V				
(Output On)	ULN2004A	VIN (ON)			6.2	_	24	V				
Input Voltage	ULN2003A	V			0		0.7	V				
(Output Off)	ULN2004A	VIN (OFF)			0	_	1.0	V				
Clamp Diode Reverse Voltage		V <sub>R</sub>			_	_	50	V				
Clamp Diode Forward Current		ΙF			_	_	350	mA				
Power Dissipation	AP	D-	Ta = 85°C		_	_	0.76	W				
	AFW	$P_{D}$	(Note) Ta = 85°C				0.325	VV				

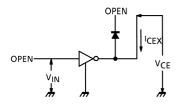
(Note) : On glass epoxy PCB (30  $\times$  30  $\times$  1.6 mm Cu 50%)

## **ELECTRICAL CHARACTERISTICS** (Ta = 25°C unless otherwise noted)

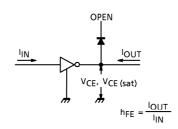
CHARACTER	ISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Output Leakage Current		I <sub>CEX</sub> 1		V <sub>CE</sub> = 50 V, Ta = 25°C			_	50	μΑ
Cutput Ecukuge eu		ICEX		$V_{CE} = 50 V$	Ta = 85°C	_	_	100	$\mu$ A
Collector-Emitter Sa	turation			I <sub>OUT</sub> = 350	mA, $I_{IN}$ = 500 $\mu$ A	_	1.3	1.6	
Voltage	itaration	VCE (sat)	2	I <sub>OUT</sub> = 200	mA, $I_{IN}$ = 350 $\mu$ A		1.1	1.3	V
Voltage				I <sub>OUT</sub> = 100	mA, $I_{1N} = 250 \mu A$		0.9	1.1	
DC Current Transfe	r Ratio	h <sub>FE</sub>	2	V <sub>CE</sub> = 2 V, I <sub>OUT</sub> = 350 mA		1000			
Input Current	ULN2003A	line (ann	3	V <sub>IN</sub> = 2.4 V, I <sub>OUT</sub> = 350 mA		_	0.4	0.7	A
(Output On)	ULN2004A	IN (ON) 3		$V_{IN} = 9.5 \text{ V, } I_{OUT} = 350 \text{ mA}$		_	0.8	1.2	mA
Input Current (Output Off)		IN (OFF)	4	I <sub>OUT</sub> = 500	$\mu$ A, Ta = 85°C	50	65	_	$\mu$ A
	111 112002 4	VIN (ON)		V <sub>CE</sub> = 2 V h <sub>FE</sub> = 800	I <sub>OUT</sub> = 350 mA	_	_	2.6	
Input Voltage	ULN2003A		5		I <sub>OUT</sub> = 200 mA	_	_	2.0	] <sub>v</sub>
(Output On)	LU NI2004A		5		I <sub>OUT</sub> = 350 mA	_	_	4.7	1 <b>v</b>
	ULN2004A				I <sub>OUT</sub> = 200 mA	_	_	4.4	
Classes Diagle Decem			_	V <sub>R</sub> = 50 V, Ta = 25°C		_	_	50	
Clamp Diode Reverse Current		l <sub>R</sub>	6	V <sub>R</sub> = 50 V, Ta = 85°C		_	_	100	μΑ
Clamp Diode Forward Voltage		VF	7	I <sub>F</sub> = 350 mA		_	_	2.0	٧
Input Capacitance		C <sub>IN</sub>	_			_	15	l —	pF
Turn-On Delay		<sup>t</sup> ON	8	$V_{OUT}$ = 50 V, $R_L$ = 125 $\Omega$ $C_L$ = 15 pF			0.1		
Turn-Off Delay		<sup>t</sup> OFF	8	$V_{OUT}$ = 50 V, $R_L$ = 125 $\Omega$ $C_L$ = 15 pF			0.2	_	μs

### **TEST CIRCUIT**

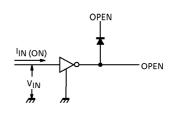
# 1. I<sub>CEX</sub>



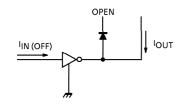
# 2. V<sub>CE</sub> (sat), h<sub>FE</sub>



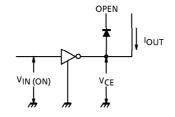
# 3. I<sub>IN</sub> (ON)



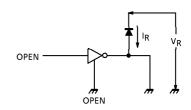
# 4. IIN (OFF)



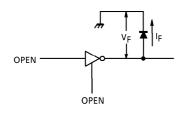
# 5. V<sub>IN</sub> (ON)



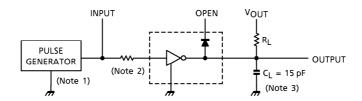
6. I<sub>R</sub>

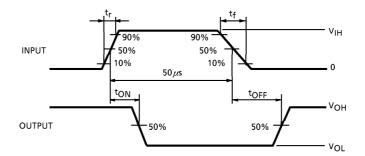


# 7. V<sub>F</sub>



### 8. ton, toff





(Note 1) : Pulse width 50  $\mu$ s, duty cycle 10%

Output impedance 50  $\Omega$ ,  $t_{\text{r}} \le$  5 ns,  $t_{\text{f}} \le$  10 ns

(Note 2) : See below

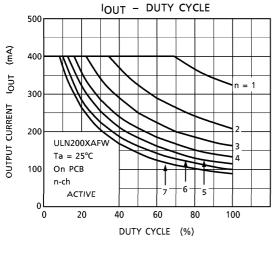
### INPUT CONDITION

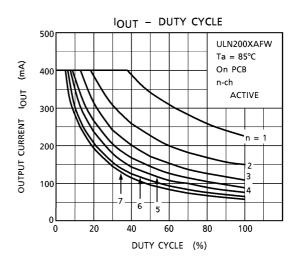
TYPE NUMBER	R1	$V_{IH}$
ULN2003AP / AFW	0	3 V
ULN2004AP / AFW	0	8 V

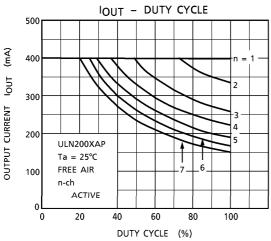
(Note 3) : C<sub>L</sub> includes probe and jig capacitance.

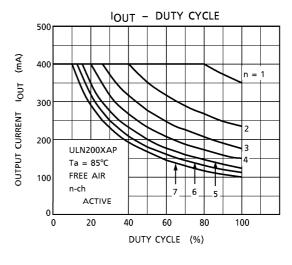
#### PRECAUTIONS for USING

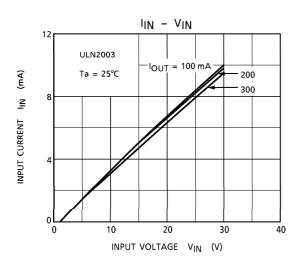
Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

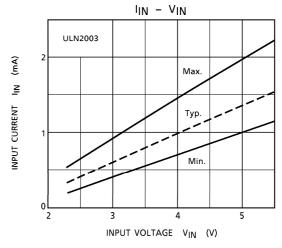


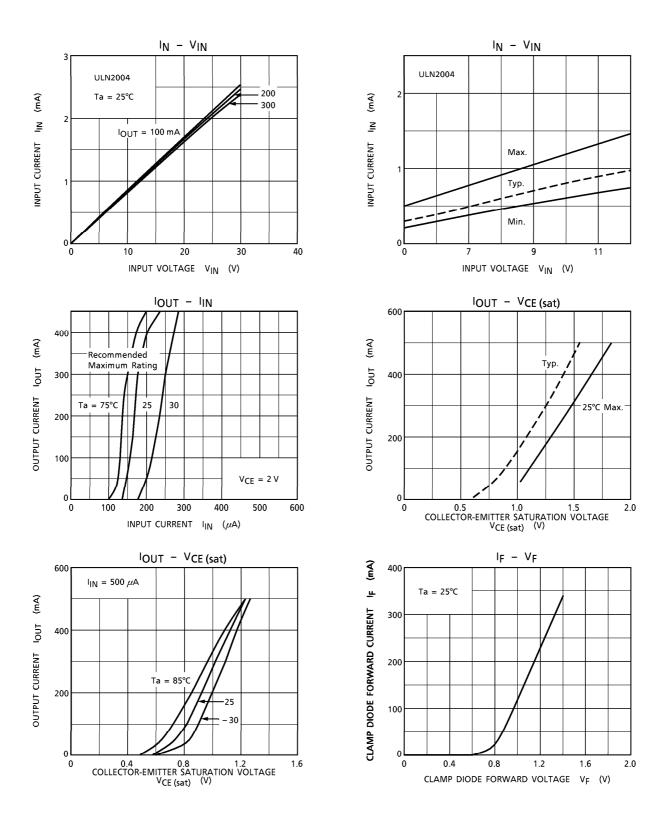


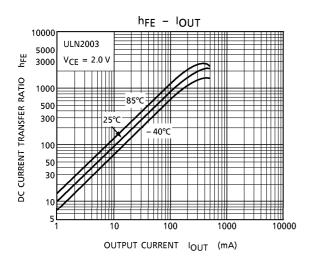


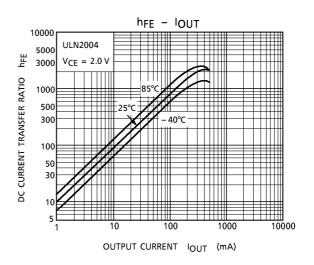


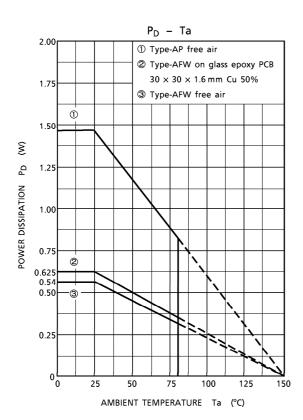






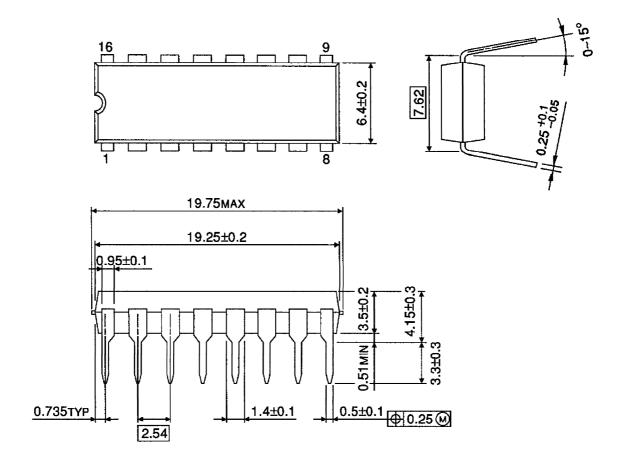






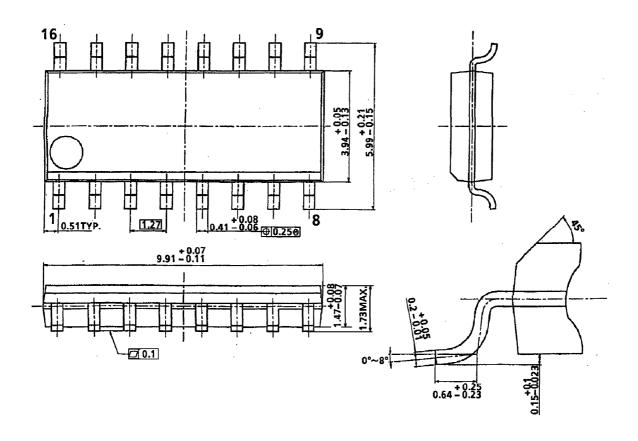
# OUTLINE DRAWING

DIP16-P-300-2.54A



Weight: 1.11 g (Typ.)

# **OUTLINE DRAWING** SOL16-P-150-1.27A



Weight: 0.15 g (Typ.)